

## FQD9N25TM\_F085

### 250V N-Channel MOSFET

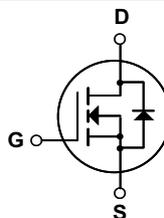
#### General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supply.

#### Features

- 7.4A, 250V,  $R_{DS(on)}=0.42\Omega @V_{GS}=10V$
- Low gate charge (typical 15.5nC)
- Low  $C_{rss}$  (typical 15pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS Compliant
- Qualified to AEC Q101



#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	FQD9N25TM F085	Units
V <sub>DSS</sub>	Drain-Source Voltage	250	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)	7.4	A
	- Continuous (T <sub>C</sub> = 100°C)	4.7	A
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)	29.6	A
V <sub>GSS</sub>	Gate-Source Voltage	± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	165	mJ
I <sub>AR</sub>	Avalanche Current (Note 1)	7.4	A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)	5.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> = 25°C) *	2.5	W
	Power Dissipation (T <sub>C</sub> = 25°C)	55	W
	- Derate above 25°C	0.44	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C

#### Thermal Characteristics

Symbol	Parameter	Typ	Max	Units
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	--	2.27	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient *	--	50	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	--	110	°C/W

\* When mounted on the minimum pad size recommended (PCB Mount)

## Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	250	--	--	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced to 25°C	--	0.2	--	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V	--	--	1	μA
		V <sub>DS</sub> = 200 V, T <sub>C</sub> = 125°C	--	--	10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V	--	--	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V	--	--	-100	nA

<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	--	5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.7 A	--	0.33	0.42	Ω
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 3.7 A (Note 4)	--	6.8	--	S

<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz	--	540	700	pF
C <sub>oss</sub>	Output Capacitance		--	110	145	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	15	20	pF

<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 125 V, I <sub>D</sub> = 9.4 A, R <sub>G</sub> = 25 Ω  (Note 4, 5)	--	13	35	ns
t <sub>r</sub>	Turn-On Rise Time		--	105	220	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	25	60	ns
t <sub>f</sub>	Turn-Off Fall Time		--	45	100	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 200 V, I <sub>D</sub> = 9.4 A, V <sub>GS</sub> = 10 V  (Note 4, 5)	--	15.5	20	nC
Q <sub>gs</sub>	Gate-Source Charge		--	3.8	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	8.5	--	nC

<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current	--	--	7.4	A	
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current	--	--	29.6	A	
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 7.4 A	--	--	1.5	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 9.4 A, di <sub>F</sub> / dt = 100 A/μs (Note 4)	--	150	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge		--	0.8	--	μC

**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. Starting T<sub>J</sub> = 25°C, L=4.8mH, I<sub>AS</sub>=7.4A, R<sub>G</sub>=25Ω, V<sub>DD</sub>=50V during the inductor charging time and 0V during the time in avalanche
3. I<sub>SD</sub> ≤ 9.4A, di/dt ≤ 300A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%
5. Essentially independent of operating temperature

## Typical Characteristics

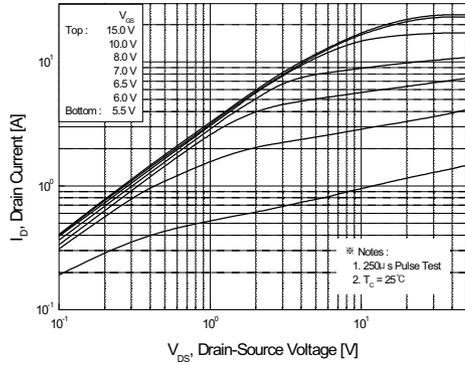


Figure 1. On-Region Characteristics

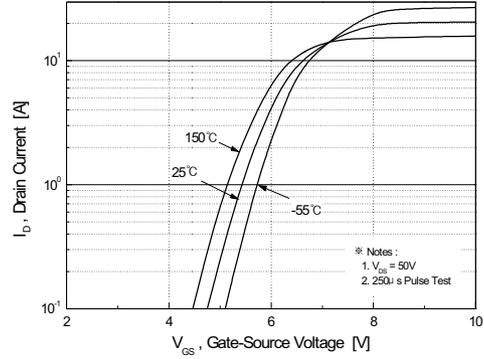


Figure 2. Transfer Characteristics

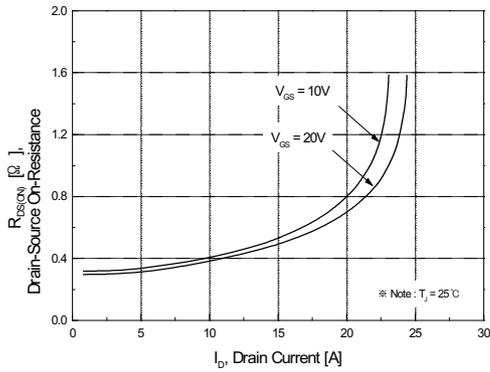


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

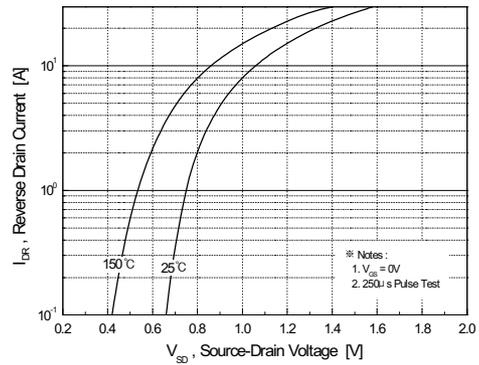


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

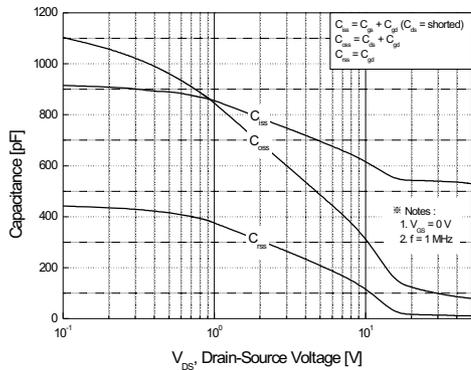


Figure 5. Capacitance Characteristics

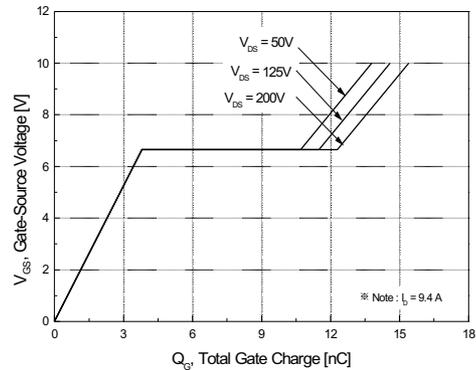
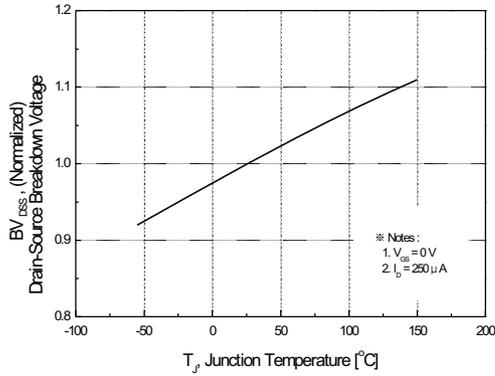
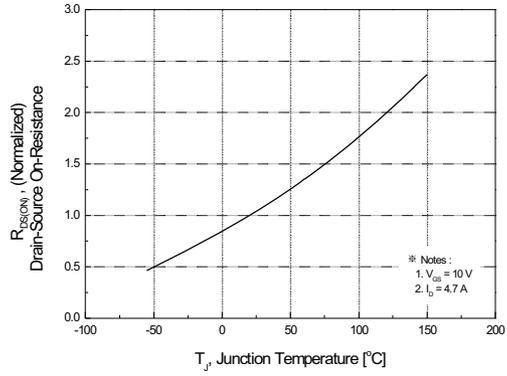


Figure 6. Gate Charge Characteristics

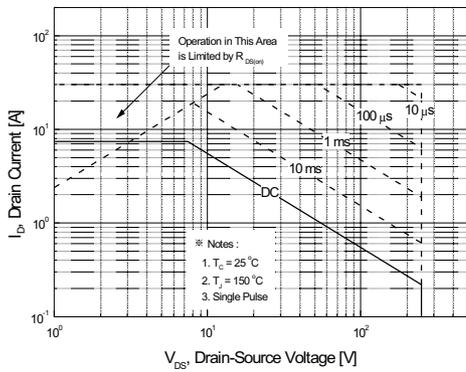
**Typical Characteristics** (Continued)



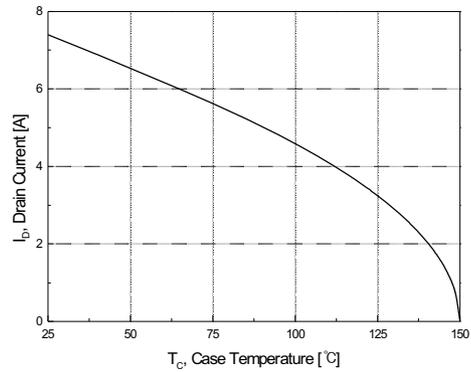
**Figure 7. Breakdown Voltage Variation vs. Temperature**



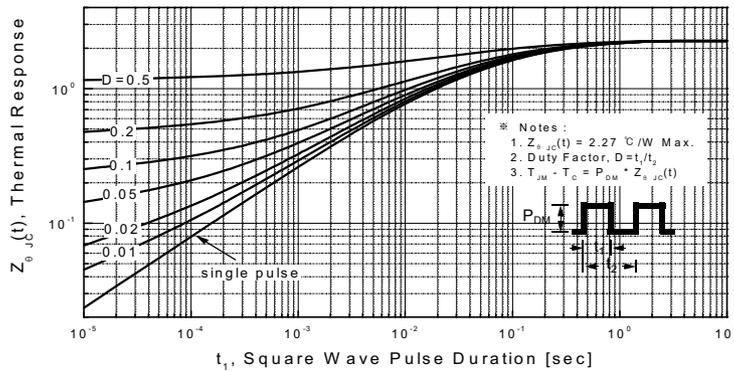
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Maximum Safe Operating Area**

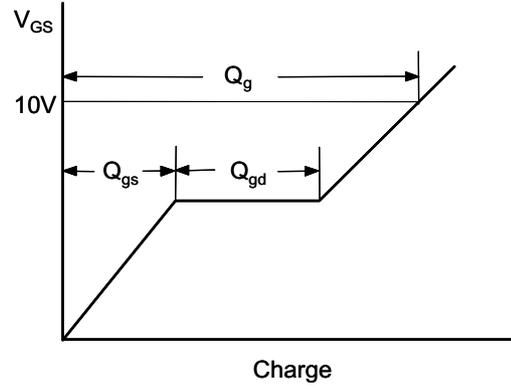
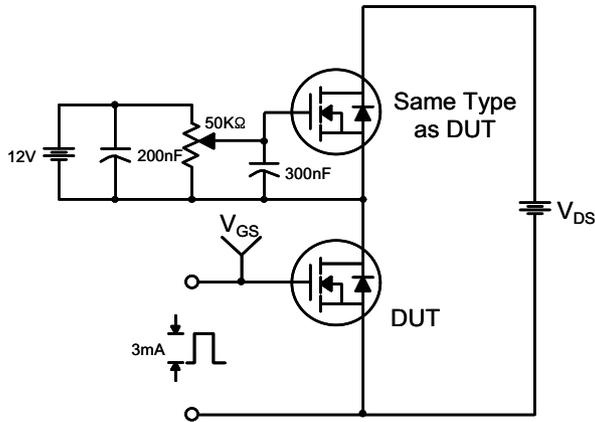


**Figure 10. Maximum Drain Current vs. Case Temperature**

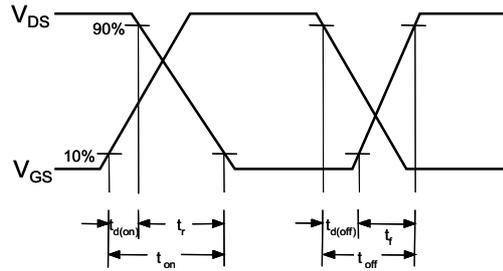
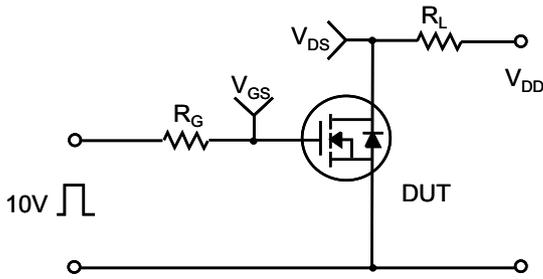


**Figure 11. Transient Thermal Response Curve**

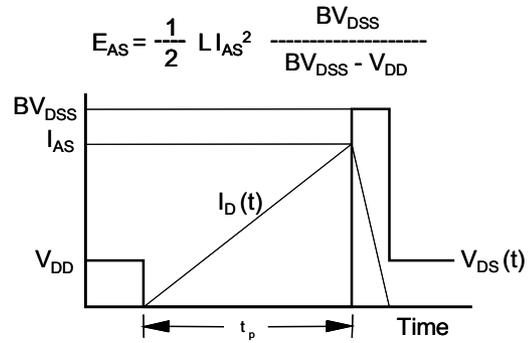
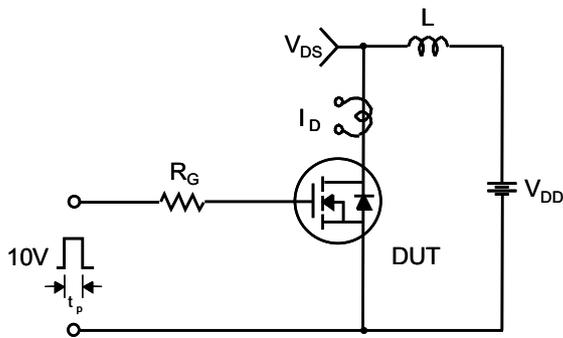
**Gate Charge Test Circuit & Waveform**



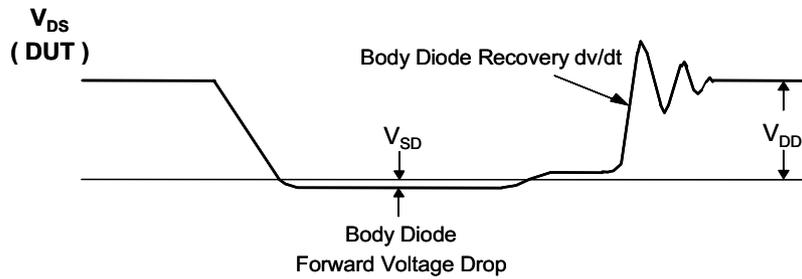
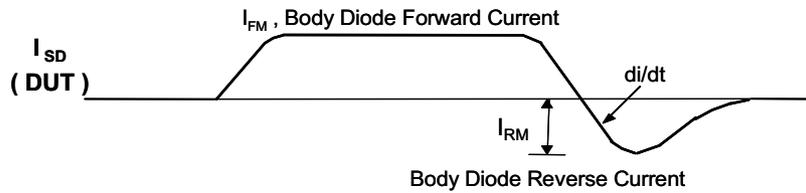
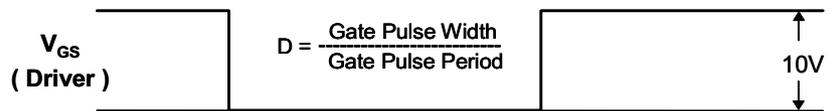
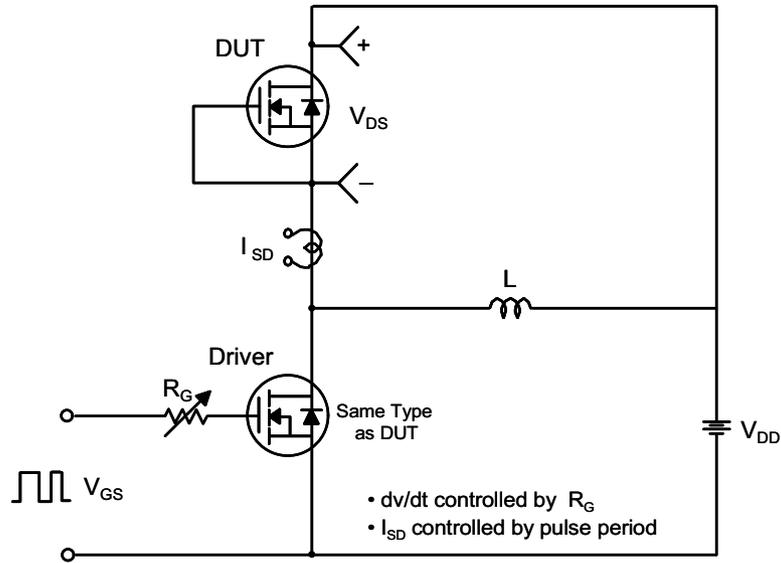
**Resistive Switching Test Circuit & Waveforms**



**Unclamped Inductive Switching Test Circuit & Waveforms**

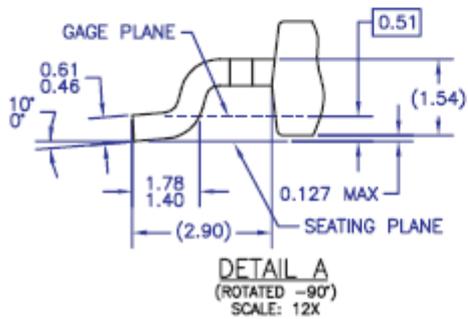
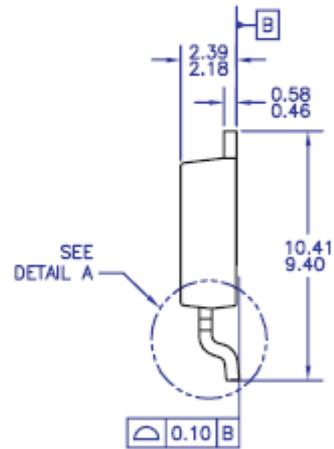
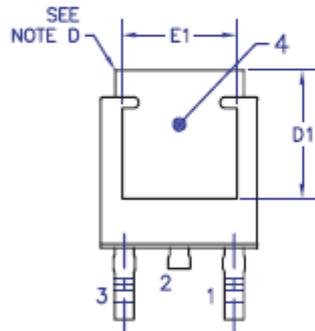
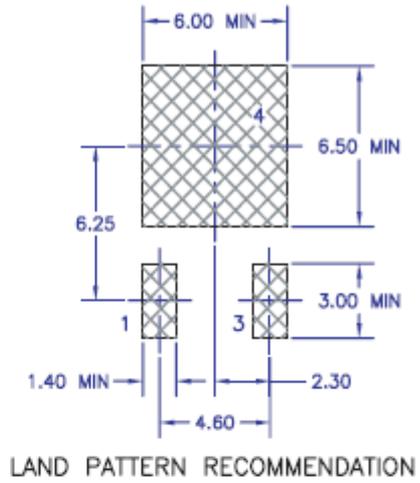
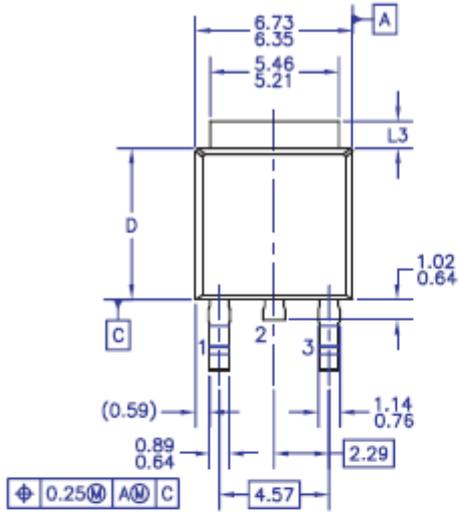


Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimensions

D - PAK



Dimensions in Millimeters



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